



Designation: B799 – 95 (Reapproved 2014)

Standard Test Method for Porosity in Gold and Palladium Coatings by Sulfurous Acid/Sulfur-Dioxide Vapor¹

This standard is issued under the fixed designation B799; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

1. Scope

1.1 This test method covers equipment and methods for determining the porosity of gold and palladium coatings, particularly electrodeposits and clad metals used on electrical contacts.

1.2 This test method is designed to show whether the porosity level is less or greater than some value which by experience is considered by the user to be acceptable for the intended application.

1.3 A variety of other porosity testing methods are described in the literature.^{2,3} Other porosity test methods are B735, B741, B798, and B809. An ASTM Guide to the selection of porosity tests for electrodeposits and related metallic coatings is available as Guide B765.

1.4 The values stated in SI units are to be regarded as standard. The values given in parentheses are for information only.

1.5 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to become familiar with all hazards including those identified in the appropriate Material Safety Data Sheet (MSDS) for this product/material as provided by the manufacturer, to establish appropriate safety and health practices, and determine the applicability of regulatory limitations prior to use.* For specific hazards, see Section 6.

¹ This test method is under the jurisdiction of ASTM Committee B02 on Nonferrous Metals and Alloys and is the direct responsibility of Subcommittee B02.11 on Electrical Contact Test Methods.

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² For example see: Nobel, F. J., Ostrow, B. D., and Thompson, D. W., "Porosity Testing of Gold Deposits," *Plating*, Vol 52, 1965, p. 1001.

³ Krumbien, S. J., "Porosity Testing of Contact Platings," *Proceedings, Connectors and Interconnection Technology Symposium*, Oct. 1987, p 47.

2. Referenced Documents

2.1 *ASTM Standards*:⁴

B374 Terminology Relating to Electroplating

B542 Terminology Relating to Electrical Contacts and Their Use

B735 Test Method for Porosity in Gold Coatings on Metal Substrates by Nitric Acid Vapor

B741 Test Method for Porosity In Gold Coatings On Metal Substrates By Paper Electrography (Withdrawn 2005)⁵

B765 Guide for Selection of Porosity and Gross Defect Tests for Electrodeposits and Related Metallic Coatings

B798 Test Method for Porosity in Gold or Palladium Coatings on Metal Substrates by Gel-Bulk Electrography

B809 Test Method for Porosity in Metallic Coatings by Humid Sulfur Vapor ("Flowers-of-Sulfur")

3. Terminology

3.1 *Definitions*—Many terms used in this test method are defined in Terminology B542 and terms relating to metallic coatings are defined in Terminology B374.

3.2 *Definitions of Terms Specific to This Standard*:

3.2.1 *corrosion products, n*—those reaction products emanating from the pores that protrude from, or are otherwise attached to, the coating surface after a vapor test exposure.

3.2.2 *measurement area (or "significant surface"), n*—the surface that is examined for the presence of porosity. The significant surfaces or measurement areas of the part to be tested shall be indicated on the drawing of the part or by provision of suitably marked samples.

3.2.2.1 *Discussion*—For specification purposes, the significant surfaces or measurement areas are often defined as those

⁴ For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

⁵ The last approved version of this historical standard is referenced on www.astm.org.

portions of the surface that are essential to the serviceability or function of the part, such as its contact properties, or which can be the source of corrosion products or tarnish films that interfere with the function of the part.

3.2.3 *metallic coatings, n*—include platings, claddings, or other metallic layers applied to the substrate. The coatings can comprise a single metallic layer or a combination of metallic layers.

3.2.4 *porosity, n*—the presence of any discontinuity, crack, or hole in the coating that exposes a different underlying metal.

3.2.5 *underplate, n*—a metallic coating layer between the substrate and the topmost layer or layers. The thickness of an underplate is usually greater than 0.8 μm (30 μin.).

4. Summary of Test Method

4.1 The test method employs concentrated sulfurous acid (H₂SO₃), which emits sulfur dioxide (SO₂) gas according to the equilibrium reaction:



The procedure is similar to one first proposed by Lee and Ternowski.⁶

4.2 Exposure periods may vary, depending upon the degree of porosity to be revealed. Reaction of the gas with a corrodable base metal at pore sites produces reaction products that appear as discrete spots on the gold or palladium surface. Individual spots are counted with the aid of a loupe or low-power stereo microscope.

4.3 This test method is suitable for coatings containing 95 % or more of gold or palladium on substrates of copper, nickel, and their alloys which are commonly used in electrical contacts.

4.4 This porosity test involves corrosion reactions in which the products delineate defect sites in coatings. Since the chemistry and properties of these products may not resemble those found in natural or service environments this test is not recommended for prediction of the electrical performance of contacts unless correlation is first established with service experience.

5. Significance and Use

5.1 Gold coatings are often specified for the contacts of separable electrical connectors and other devices. Electrodeposits are the form of gold that is most used on contacts, although it is also employed as inlay or clad metal and as weldments on the contact surface. The intrinsic nobility of gold enables it to resist the formation of insulating oxide films that could interfere with reliable contact operation.

5.2 Palladium coatings are sometimes specified as alternatives to gold on electrical contacts and similar electrical component surfaces, both as electrodeposits and as inlay or clad metal. This test method is particularly suitable for determining porosity in palladium coatings, since the reactive

atmosphere that is used does not attack the palladium if the specified test conditions are followed. In contrast, palladium coatings are attacked by nitric acid (HNO₃) and other strong oxidizing agents, so that Test Method B735 cannot be used for determining the porosity in such coatings.

5.3 In order for these coatings to function as intended, porosity, cracks, and other defects in the coating that expose base-metal substrates and underplates must be minimal or absent, except in those cases where it is feasible to use the contacts in structures that shield the surface from the environment or where corrosion inhibiting surface treatments for the deposit are employed. The level of porosity in the coating that may be tolerable depends on the severity of the environment to the underplate or substrate, design factors for the contact device like the force with which it is mated, circuit parameters, and the reliability of contact operation that it is necessary to maintain. Also, when present, the location of pores on the surface is important. If the pores are few in number and are outside of the zone of contact of the mating surfaces, their presence can often be tolerated.

5.4 Methods for determining pores on a contact surface are most suitable if they enable their precise location and numbers to be determined. Contact surfaces are often curved or irregular in shape, and testing methods should be suitable for them. In addition, the severity of porosity-determining tests may vary from procedures capable of detecting all porosity to procedures that detect only highly porous conditions.

5.5 The present test method is capable of detecting virtually all porosity or other defects that could participate in corrosion reactions with the substrate or underplate. The test is rapid, simple, and inexpensive. In addition, it can be used on contacts having complex geometry such as pin-socket contacts (although with deep recesses it is preferred that the contact structures be opened to permit reaction of the sulfur dioxide with the interior significant surfaces).

5.6 The relationship of porosity levels revealed by particular tests to contact behavior must be made by the user of these tests through practical experience or by judgment. Thus, absence of porosity in the coating may be a requirement for some applications, while a few pores in the contact zone may be acceptable for others.

5.7 This test is considered destructive in that it reveals the presence of porosity by contaminating the surface with corrosion products and by undercutting the coating at pore sites or at the boundaries of the unplated areas. Any parts exposed to this test shall not be placed in service.

5.8 This test is intended to be used for quantitative descriptions of porosity (such as number of pores per unit area or per contact) only on coatings that have a pore density sufficiently low that the corrosion sites are well separated and can be readily resolved. As a general guideline this can be achieved for pore densities up to about 100/cm². Above this value the tests are useful for the qualitative detection and comparisons of porosity.

5.9 For these purposes, the *measurement area*, or *significant surface*, shall be defined as those portions of the surface that

⁶ Lee, F. and Ternowski, M., *Proceedings Ninth International Conference on Electrical Contact Phenomena*, Chicago, 1978, p. 215.